

Electronic Acknowledgement Receipt

EFS ID:	1169822
Application Number:	10566949
Confirmation Number:	3062
Title of Invention:	Plating solution, process for producing a structure with the plating solution, and apparatus employing the plating solution
First Named Inventor:	Shigeru Ichihara
Customer Number:	5514
Filer:	Jason M. Okun/DAVID NGUY
Filer Authorized By:	Jason M. Okun
Attorney Docket Number:	03500.103072
Receipt Date:	24-AUG-2006
Filing Date:	03-FEB-2006
Time Stamp:	16:48:49
Application Type:	U.S. National Stage under 35 USC 371
International Application Number:	

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Request for Corrected Filing Receipt	ReqCorrOFR03500103072U SB100.pdf	5356	no	2

Warnings:	
Information:	
Total Files Size (in bytes):	5356
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